US Micro Products
Electronic Products for the OEM

OLED PRODUCT SPECIFICATION

Manufactured by:

RITEK GROUP
RiTdisplay Corporation

PART NUMBER:	**USMP-P19601**
DESCRIPTION:	1.1", 96 x 64, Yellow, SSD1325 IC

ISSUE DATE	APPROVED BY (Customer Use Only)	CHECKED BY	PREPARED BY
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REVISION RECORD

REV.	REVISION DESCRIPTION	REV. DATE	REMARK
X01	INITIAL RELEASE	2007. 11. 19	
X02	■ Modify panel size	2007. 12. 14	Page 5 & 19
X03	■ Add the operating conditions for different luminance ■ Add the panel electrical specifications ■ Modify power off sequence ■ Add the application circuit	2008. 02. 05	Page 6, 7, 8, 16, 17 & 18
A01	■ Transfer from X version ■ Add the information of module weight ■ Add the packing specification	2008. 03. 20	Page 5 & 21

CONTENTS

1. SCOPE

This specification is to define the general provisions and quality requirements that apply to the supply of display cells manufactured by RiTdisplay. This document, together with the Module Ass'y Drawing, is the highest-level specification for this product.

2. WARRANTY

RiTdisplay warrants that the products delivered pursuant to this specification (or order) will conform to the agreed specifications for twelve (12) months from the shipping date ("Warranty Period"). RiTdisplay is obligated to repair or replace the products which are found to be defective or inconsistent with the specifications during the Warranty Period without charge, on condition that the products are stored or used as the conditions specified in the specifications. Nevertheless, RiTdisplay is not obligated to repair or replace the products without charge if the defects or inconsistency are caused by the force majeure or the reckless behaviors of the customer.
After the Warranty Period, all repairs or replacements of the products are subject to charge.

3. FEATURES

Small molecular organic light emitting diode
Color : Yellow
Panel matrix : 96*64
Driver IC : SSD1325 (16 Gray scale)
Excellent quick response time.
Extremely thin thickness for best mechanism design : 1.61mm
High contrast : 2000:1
Wide viewing angle : 160°
8-bit 6800-series parallel interface, 8-bit 8080-series parallel interface, serial peripheral interface
Wide range of operating temperature : -40 to 70 °C
Anti-glare polarizer.

4. MECHANICAL DATA

NO	ITEM	SPECIFICATION	UNIT
1	Dot Matrix	96 (W) x 64 (H)	dot
2	Dot Size	0.215 (W) x 0.215 (H)	mm^2
3	Dot Pitch	0.245 (W) x 0.245 (H)	mm^2
4	Aperture Rate	77	%
5	Active Area	23.49 (W) x 15.65 (H)	mm^2
6	Panel Size	29 (W) x 21 (H)	mm^2
7	Panel Thickness	1.61 ± 0.1	mm
8	Module Size	29 (W) x 35.5 (H) x 1.61 (D)	mm^3
9	Diagonal A/A size	1.1	inch
10	Module Weight	2.15 ± 10%	gram

5. MAXIMUM RATINGS

ITEM	MIN	MAX	UNIT	Condition	Remark
Supply Voltage (V_{DD})	-0.3	3.5	V	Ta = 25°C	IC maximum rating
Supply Voltage (Vcc)	8	16	V	Ta = 25°C	IC maximum rating
Operating Temp.	-40	70	°C		
Storage Temp	-40	85	°C		
Humidity	-	85	%		
Life Time	33,000	-	Hrs	120 cd/m^2, 50% checkerboard	Note (1)
Life Time	40,000	-	Hrs	100 cd/m^2, 50% checkerboard	Note (2)
Life Time	50,000	-	Hrs	80 cd/m^2, 50% checkerboard	Note (3)

Note:

(A) Under Vcc = 12V, Ta = 25°C, 50% RH.

(B) Life time is defined the amount of time when the luminance has decayed to less than 50% of the initial measured luminance.

(1) Setting of 120 cd/m^2 :

- Contrast setting : 0x73
- Frame rate : 105Hz
- Duty setting : 1/64

(2) Setting of 100 cd/m^2 :

- Contrast setting : 0x56
- Frame rate : 105Hz
- Duty setting : 1/64

(3) Setting of 80 cd/m^2 :

- Contrast setting : 0x40
- Frame rate : 105Hz
- Duty setting : 1/64

6. ELECTRICAL CHARACTERISTICS

6.1 D.C ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETERS	TEST CONDITION	MIN	TYP	MAX	UNIT
V_{CC}	Analog power supply (for OLED panel)	Ta=-20 ℃ to +70°C	11.5	12	12.5	V
V_{DD}	Digital power supply	Ta=-20 ℃ to +70°C	2.4	2.7	3.5	V
I_{DD}	Operating current for V_{DD} V_{DD} = 2.7V, V_{CC} = 12V, IREF = 10uA No panel attached, All Display ON	Contrast=7F	-	-	650	uA
I_{CC}	Operating current for V_{CC} V_{DD} = 2.7V, V_{CC} = 12V, IREF = 10uA No panel attached, All Display ON	Contrast=7F	-	700	-	uA
V_{IH}	Hi logic input level		0.8* V_{DD}	-	V_{DD}	V
V_{IL}	Low logic input level		0	-	0.2* V_{DD}	V
V_{OH}	Hi logic output level		0.9* V_{DD}	-	V_{DD}	V
V_{OL}	Low logic output level		0	-	0.1* V_{DD}	V
I_{SEG}	Segment on output current V_{DD}=2.7V, V_{CC}=12V, IREF=10uA, Display on.	Contrast=7F	270	300	370	uA
		Contrast=5F	-	225	-	uA
		Contrast=3F	-	150	-	uA
		Contrast=1F	-	75	-	uA

Note 1: V_{DD}=2.7V；V_{CC}=12V；Frame rate=105Hz；No panel attached.

Note 2: The Vcc input must keep in a stable value; ripple and noise are not allowed.

6.2 ELECTRO-OPTICAL CHARATERISTICS

PANEL ELECTRICAL SPECIFICATIONS

PARAMETER	MIN	TYP.	MAX	UNITS	COMMENTS
Normal mode current		9	11	mA	All pixels on (1)
Standby mode current		1	2	mA	Standby mode 10% pixels on (2)
Normal mode power consumption		108	132	mW	All pixels on (1)
Standby mode power consumption		12	24	mW	Standby mode 10% pixels on (2)
Normal Luminance	80	100		cd/m^2	Display Average
Standby Luminance		20		cd/m^2	Display Average
CIEx (Yellow)	0.43	0.47	0.51		x, y (CIE 1931)
CIEy (Yellow)	0.45	0.49	0.53		
Dark Room Contrast	2000:1				
Viewing Angle	160			degree	
Response Time		10		μs	

(1) Normal mode condition :

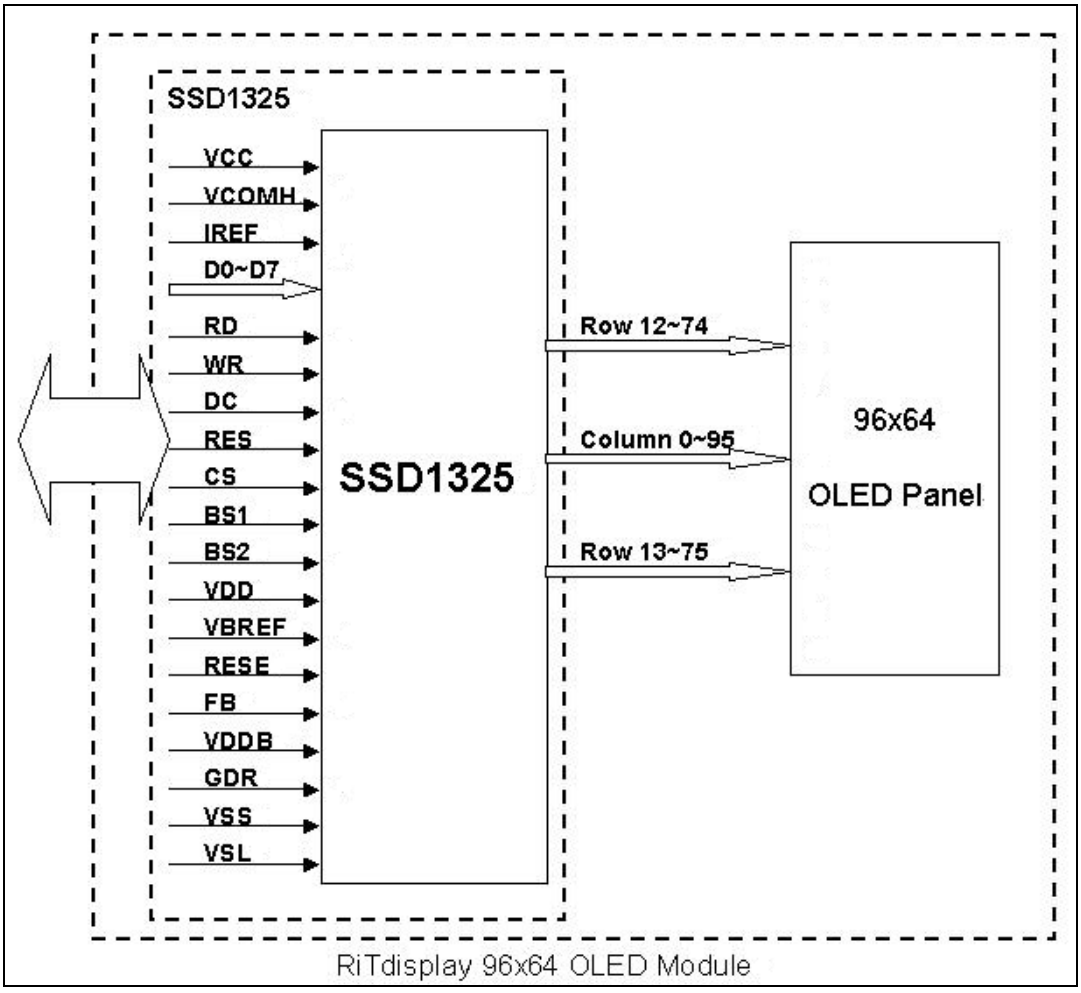
- Driving Voltage : 12V
- Contrast setting : 0x56
- Frame rate : 105Hz
- Duty setting : 1/64

(2) Standby mode condition :

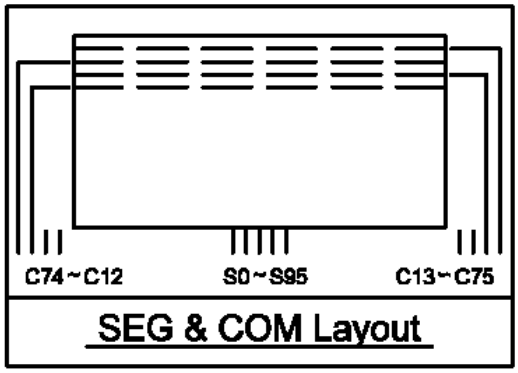
- Driving Voltage : 12V
- Contrast setting : 0x0F
- Frame rate : 105Hz
- Duty setting : 1/64

7. INTERFACE

7.1 FUNCTION BLOCK DIAGRAM



7.2 PANEL LAYOUT DIAGRAM



7.3 PIN ASSIGNMENTS

Pin No.	Pin Name	TYPE	Description
1	NC	-	No connection.
2	VCC	I	Voltage source input for OLED operating.
3	VCOMH	O	A capacitor should be connected between this pin and VSS.
4	IREF	I	A resistor should be connected between this pin and VSS.
5	D7	I/O	Bi-direction data singal.
6	D6		
7	D5		
8	D4		
9	D3		
10	D2		
11	D1		
12	D0		
13	RD	I	Data read operation is initiated when it's pull low.
14	WR	I	Data write operation is initiated when it's pull low.
15	D/C	I	This is Data/Command Control pin. H:Data Input、L:Command Input.
16	RES	I	When the pin is LOW, initialization of the chip is executed.
17	CS	I	This pin is the chip select input.
18	NC	-	No connection.
19	BS2	I	MCU interface selection input.
20	BS1		
21	VDD	I	Voltage Power supply for logic.
22	NC	-	No connection.
23	NC	-	No connection.
24	NC	-	No connection.
25	VBREF	I	This is an internal voltage reference pin. It should be kept NC and left open.
26	RESE	I	This is a reserved pin. It should be kept NC.
27	FB	I	This is a reserved pin. It should be kept NC.
28	VDDB	I	This is a reserved pin. Voltage source input for logic circuit.
29	GDR	I	This is a reserved pin. It should be kept NC.
30	VSS	I	This is a ground pin.
31	VSL	I	This pin can be kept NC or connected with a capacitor to VSS for stability.

7.4 GRAPHIC DISPLAY DATA RAM ADDRESS MAP

The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 128x80x4 bits. For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software. (Refer to Table 3-7 for GDDRAM address map description)

		SEG0	SEG1	SEG2	SEG3		SEG124	SEG125	SEG126	SEG127
		00		01			3E		3F	
COM0	00	D0[3:0]	D0[7:4]	D1[3:0]	D1[7:4]		D62[3:0]	D62[7:4]	D63[3:0]	D63[7:4]
COM1	01	D64[3:0]	D64[7:4]	D65[3:0]	D65[7:4]		D126[3:0]	D126[7:4]	D127[3:0]	D127[7:4]
|	|								
COM78	4E	D4992[3:0]	D4992[7:4]	D4993[3:0]	D4993[7:4]		D5054[3:0]	D5054[7:4]	D5055[3:0]	D5055[7:4]
COM79	4F	D5056[3:0]	D5056[7:4]	D5057[3:0]	D5057[7:4]		D5118[3:0]	D5118[7:4]	D5119[3:0]	D5119[7:4]

SEG Outputs Column Address (HEX)

COM Outputs / Row Address (HEX)

(Display Startline=0)

Table 3 GDDRAM address map showing Horizontal Address Increment A[2]=0, Column Address Re-map A[0]=0, Nibble Re-map A[1]=0, COM Re-map A[4]=0, and Display Start Line=00H (Data byte sequence: D0, D1, … , D5118, D5119)

		SEG0	SEG1	SEG2	SEG3		SEG124	SEG125	SEG126	SEG127
		00		01			3E		3F	
COM0	00	D0[3:0]	D0[7:4]	D80[3:0]	D80[7:4]		D4960[3:0]	D4960[7:4]	D5040[3:0]	D5040[7:4]
COM1	01	D1[3:0]	D1[7:4]	D81[3:0]	D81[7:4]		D4961[3:0]	D4961[7:4]	D5041[3:0]	D5041[7:4]
|	|								
COM78	4E	D78[3:0]	D78[7:4]	D158[3:0]	D158[7:4]		D5038[3:0]	D5038[7:4]	D5118[3:0]	D5118[7:4]
COM79	4F	D79[3:0]	D79[7:4]	D159[3:0]	D159[7:4]		D5039[3:0]	D5039[7:4]	D5119[3:0]	D5119[7:4]

SEG Outputs Column Address (HEX)

COM Outputs / Row Address (HEX)

(Display Startline=0)

Table 4 GDDRAM address map showing Horizontal Address Increment A[2]=1, Column Address Re-map A[0]=0, Nibble Re-map A[1]=0, COM Re-map A[4]=0, and Display Start Line=00H (Data byte sequence: D0, D1, … , D5118, D5119)

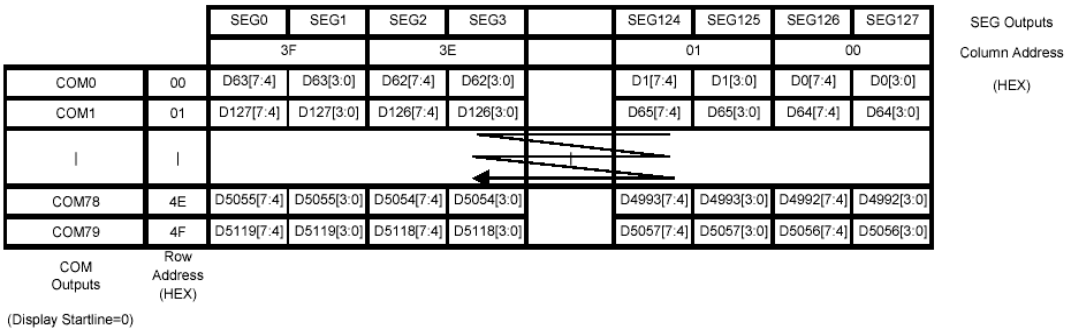


Table 5 GDDRAM address map showing Horizontal Address Increment A[2]=0, Column Address Re-map A[0]=1, Nibble Re-map A[1]=1, COM Re-map A[4]=0, and Display Start Line=00H (Data byte sequence: D0, D1, … , D5118, D5119)

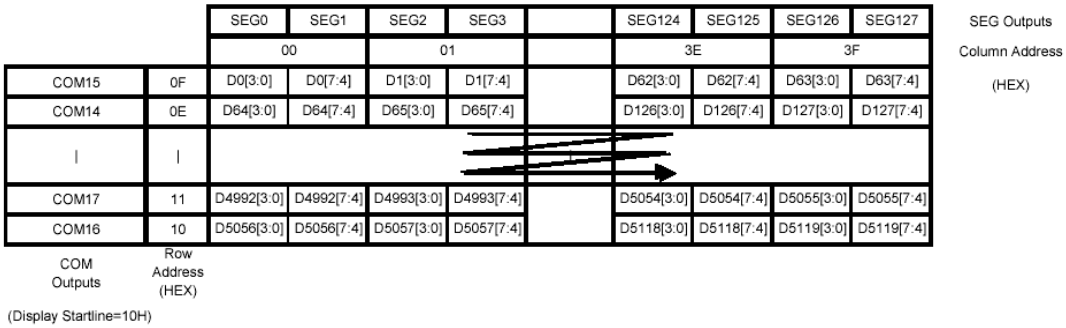


Table 6 GDDRAM address map showing Horizontal Address Increment A[2]=0, Column Address Re-map A[0]=0, Nibble Re-map A[1]=0, COM Re-map A[4]=1, and Display Start Line=16H (Data byte sequence: D0, D1, … , D5118, D5119)

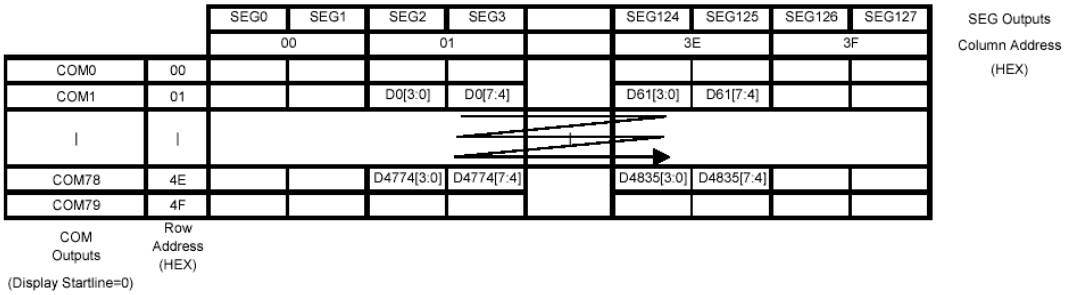


Table 7 GDDRAM address map showing Horizontal Address Increment A[2]=0, Column Address Re-map A[0]=0, Nibble Re-map A[1]=0, COM Re-map A[4]=0, Display Start Line=00H (Data byte sequence: D0, D1, … , D4834, D4835), Column Start Address=01H, Column End Address=3EH, Row Start Address=01H and Row End Address=4EH

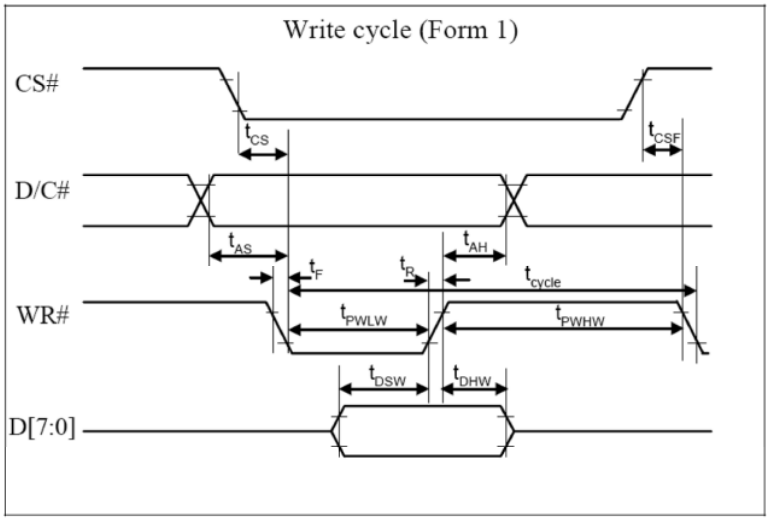
7.5 INTERFACE TIMING CHART

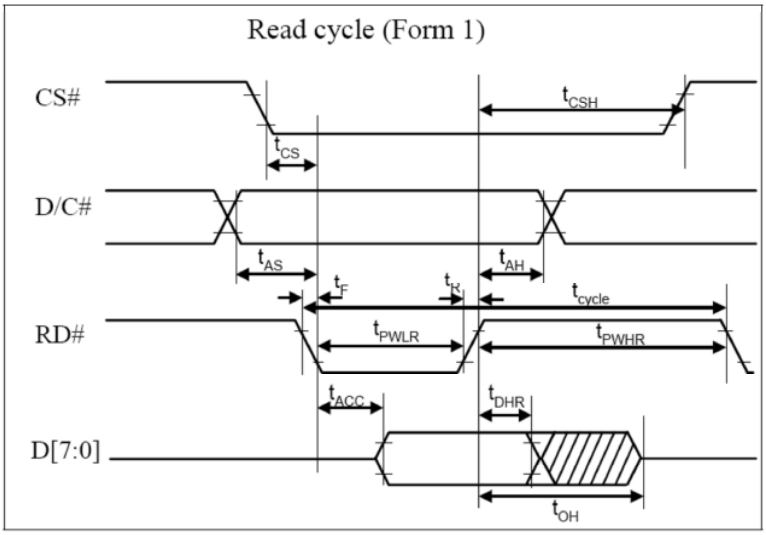
8080-Series MPU Parallel Interface Timing Characteristics

(V_{DD} - V_{SS} = 2.4 to 3.5V, T_A = 25°C)

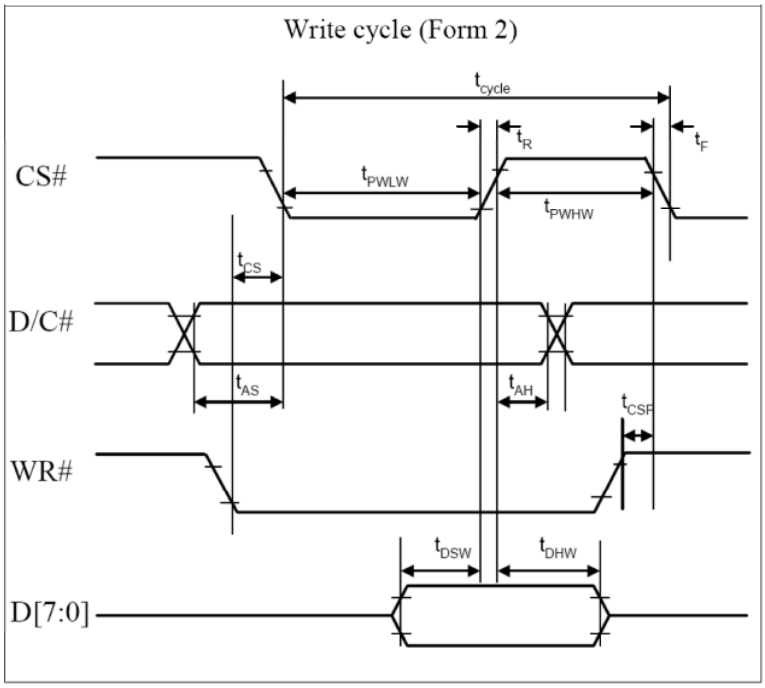
Symbol	Parameter	Min	Typ	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	-	ns
t_{AS}	Address Setup Time	10	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	40	-	-	ns
t_{DHW}	Write Data Hold Time	15	-	-	ns
t_{DHR}	Read Data Hold Time	20	-	-	ns
t_{OH}	Output Disable Time	-	-	70	ns
t_{ACC}	Access Time	-	-	140	ns
t_{PWLR}	Read Low Time	120	-	-	ns
t_{PWLW}	Write Low Time	60	-	-	ns
t_{PWHR}	Read High Time	60	-	-	ns
t_{PWHW}	Write High Time	60	-	-	ns
t_R	Rise Time	-	-	15	ns
t_F	Fall Time	-	-	15	ns
t_{CS}	Chip select setup time	0	-	-	ns
t_{CSH}	Chip select hold time to read signal	0	-	-	ns
t_{CSF}	Chip select hold time	20	-	-	ns

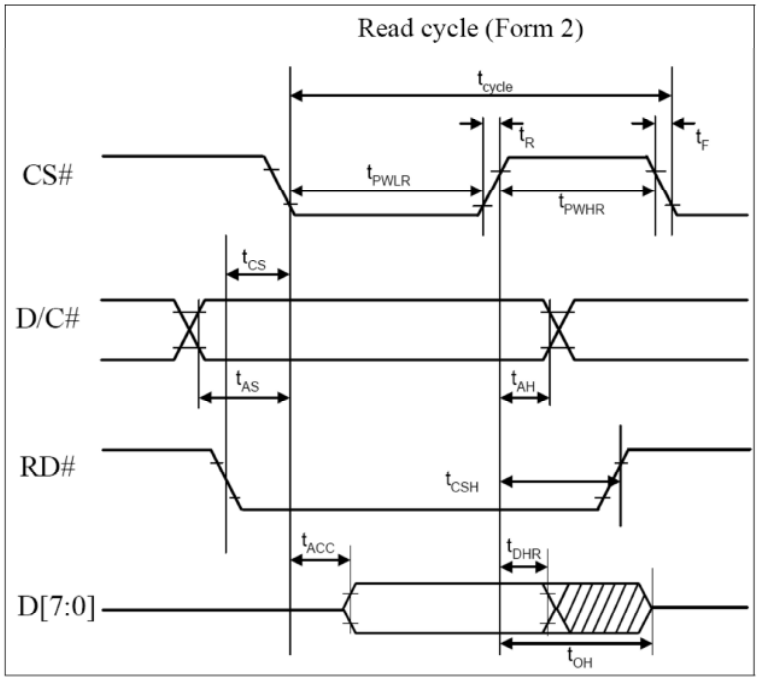
8080-series parallel interface characteristics (Form 1)





8080-series parallel interface characteristics (Form2)



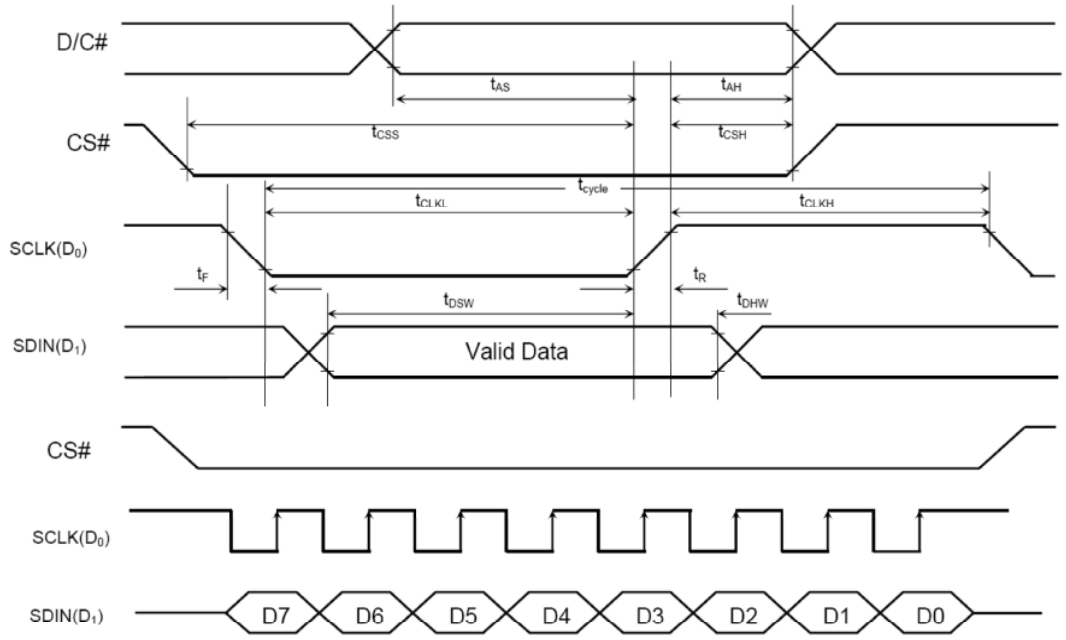


Serial Interface Timing Characteristics

(V_{DD} - V_{SS} = 2.4 to 3.5V, T_A = 25°C)

Symbol	Parameter	Min	Typ	Max	Unit
t_{cycle}	Clock Cycle Time	250	-	-	ns
t_{AS}	Address Setup Time	150	-	-	ns
t_{AH}	Address Hold Time	150	-	-	ns
t_{CSS}	Chip Select Setup Time	120	-	-	ns
t_{CSH}	Chip Select Hold Time	60	-	-	ns
t_{DSW}	Write Data Setup Time	100	-	-	ns
t_{DHW}	Write Data Hold Time	100	-	-	ns
t_{CLKL}	Clock Low Time	100	-	-	ns
t_{CLKH}	Clock High Time	100	-	-	ns
t_R	Rise Time	-	-	15	ns
t_F	Fall Time	-	-	15	ns

Serial Interface Characteristics

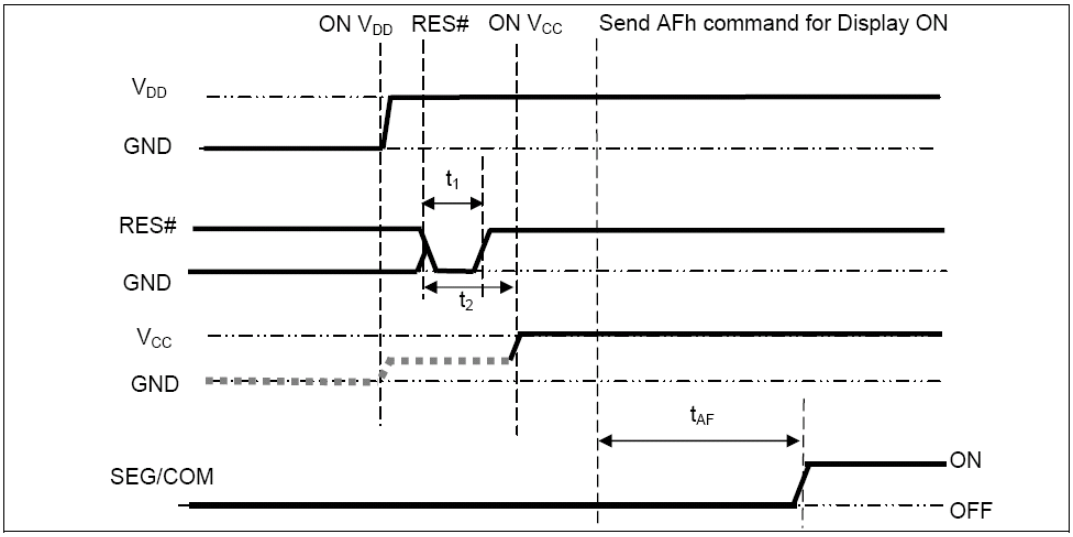


8. POWER ON / OFF SEQUENCE & APPLICATION CIRCUIT

8.1 POWER ON / OFF SEQUENCE

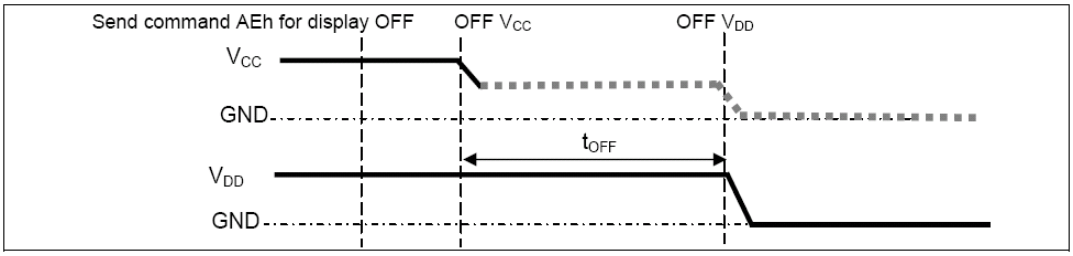
***Power ON sequence**:*

1. Power ON V_{DD}.
2. After V_{DD} become stable, set RES# pin LOW (logic low) for at least 3us(t_1) and then HIGH (logic high).
3. After set RES# pin LOW (logic low), wait for at least 3us(t_2).Then Power ON V_{CC}.(1)
4. After V_{CC} become stable, send command AFh for display ON. SEG/COM will be ON after 100ms(t_{AF}).



Power OFF sequence:

1. Send command AEh for display OFF.
2. Wait until panel discharges completely.
3. Power OFF V_{CC}. (1), (2)
4. Wait for t_{OFF}. Power OFF V_{DD}. (where Minimum t_{OFF}=80ms, Typical t_{OFF}=100ms)

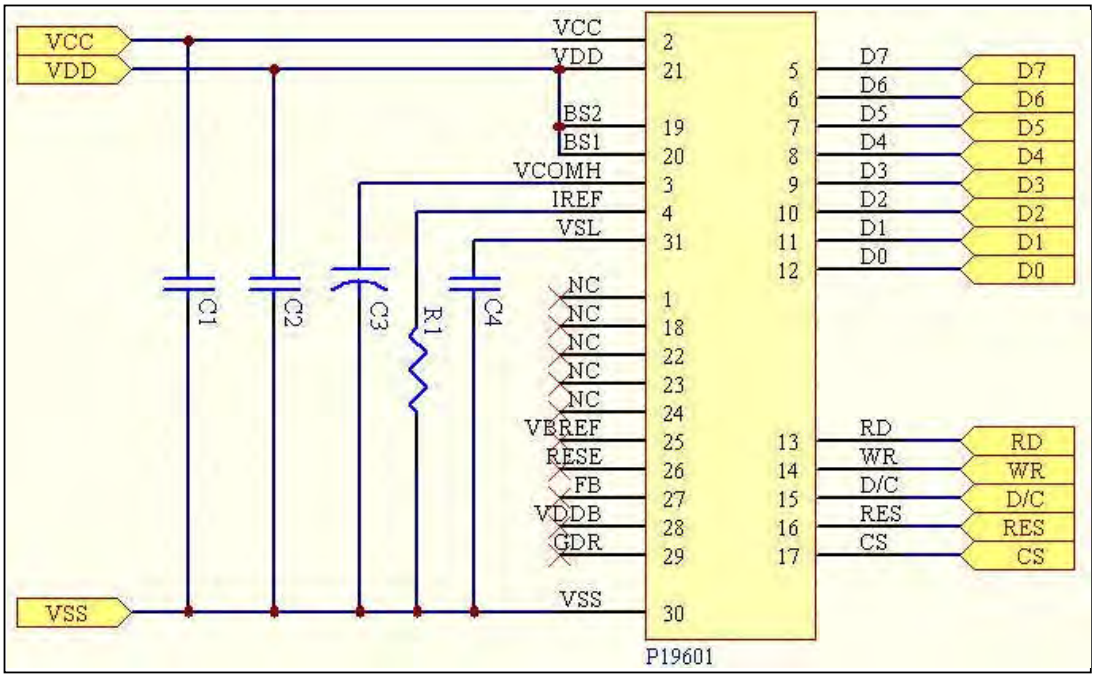


Note:

(1) Since an ESD protection circuit is connected between V_{DD} and V_{CC}, V_{CC} becomes lower than V_{DD} whenever V_{DD} is ON and V_{CC} is OFF as shown in the dotted line of V_{CC} in above figures.

(2) V_{CC} should be disabled when it is OFF.

8.2 APPLICATION CIRCUIT



Recommend components:

C1: 4.7uF/16V (0805)

C2: 0.1uF/16V (0603)

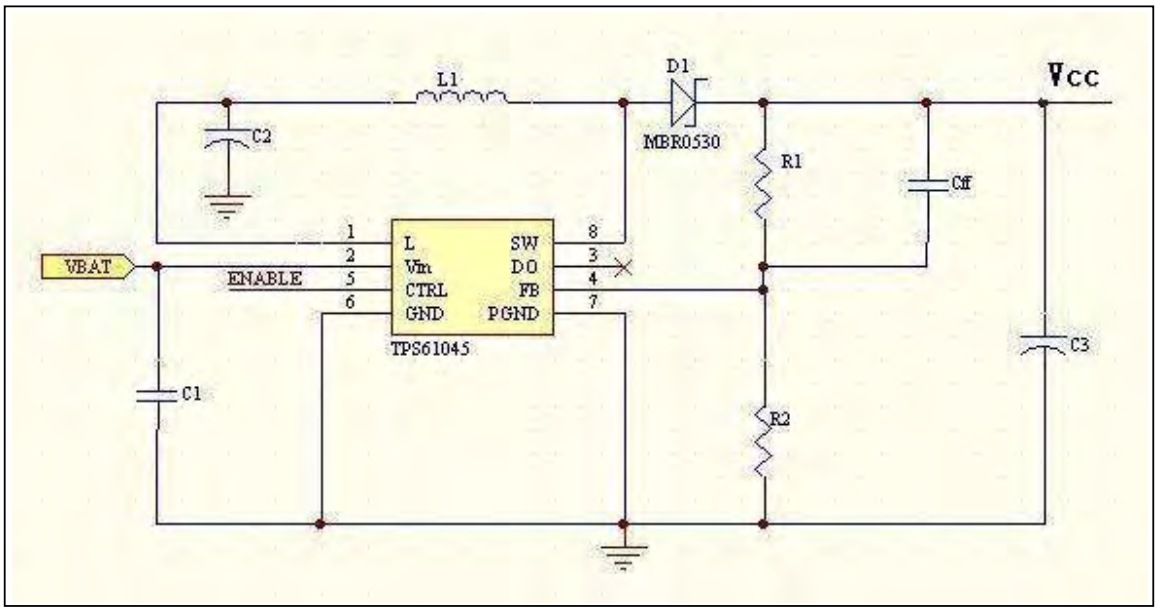
C3: 4.7uF/25V (Tantalum type),or Solid Tantalum 4.7uF/ 25V/ A Case (Vishay 572D)

C4: 0.1uF/16V (0603)

R1: 1M ohm(0603),1%

This circuit is for 8080 interface.

EXTERNAL DC-DC APPLICATION CIRCUIT



Recommended components

C1 : 100nF(0603) / 25V, C2 : 4.7uF (Tantalum type) /25V.

C3 : 4.7uF (Tantalum type) / 25V.

Cff : 22pF(0603) / 16V.

D1 : Schotty Diode.

L1 : 10uH.

R1 : 1M ohm (0603), 1%, R2: 114K ohm (0603), 1%.

VBAT = 1.8V ~ 6.0V(The detail application, please refer the IC data sheet).

8.3 COMMAND TABLE

Refer to SSD1325 IC Spec.

9. RELIABILITY TEST CONDITIONS

No.	Items	Specification	Quantity
1	High temp. (Non-operation)	85°C, 240hrs	5
2	High temp. (Operation)	70°C, 120hrs	5
3	Low temp. (Operation)	-40°C, 120hrs	5
4	High temp. / High humidity (Operation)	65°C, 90%RH, 120hrs	5
5	Thermal shock (Non-operation)	-40°C ~85°C (-40°C /30min; transit /3min; 85°C /30min; transit /3min) 1cycle: 66min, 100 cycles	5
6	Vibration	Frequency : 5~50HZ, 0.5G Scan rate : 1 oct/min Time : 2 hrs/axis Test axis : X, Y, Z	1 Carton
7	Drop	Height: 120cm Sequence : 1 angle、3 edges and 6 faces Cycles: 1	1 Carton
8	ESD (Non-operation)	Air discharge model, ±8kV, 10 times	5

Test and measurement conditions

1. All measurements shall not be started until the specimens attain to temperature stability.
2. All-pixels-on is used as operation test pattern.
3. The degradation of Polarizer are ignored for item 1, 4 & 5.

Evaluation criteria

1. The function test is OK.
2. No observable defects.
3. Luminance: > 50% of initial value.
4. Current consumption: within ± 50% of initial value.

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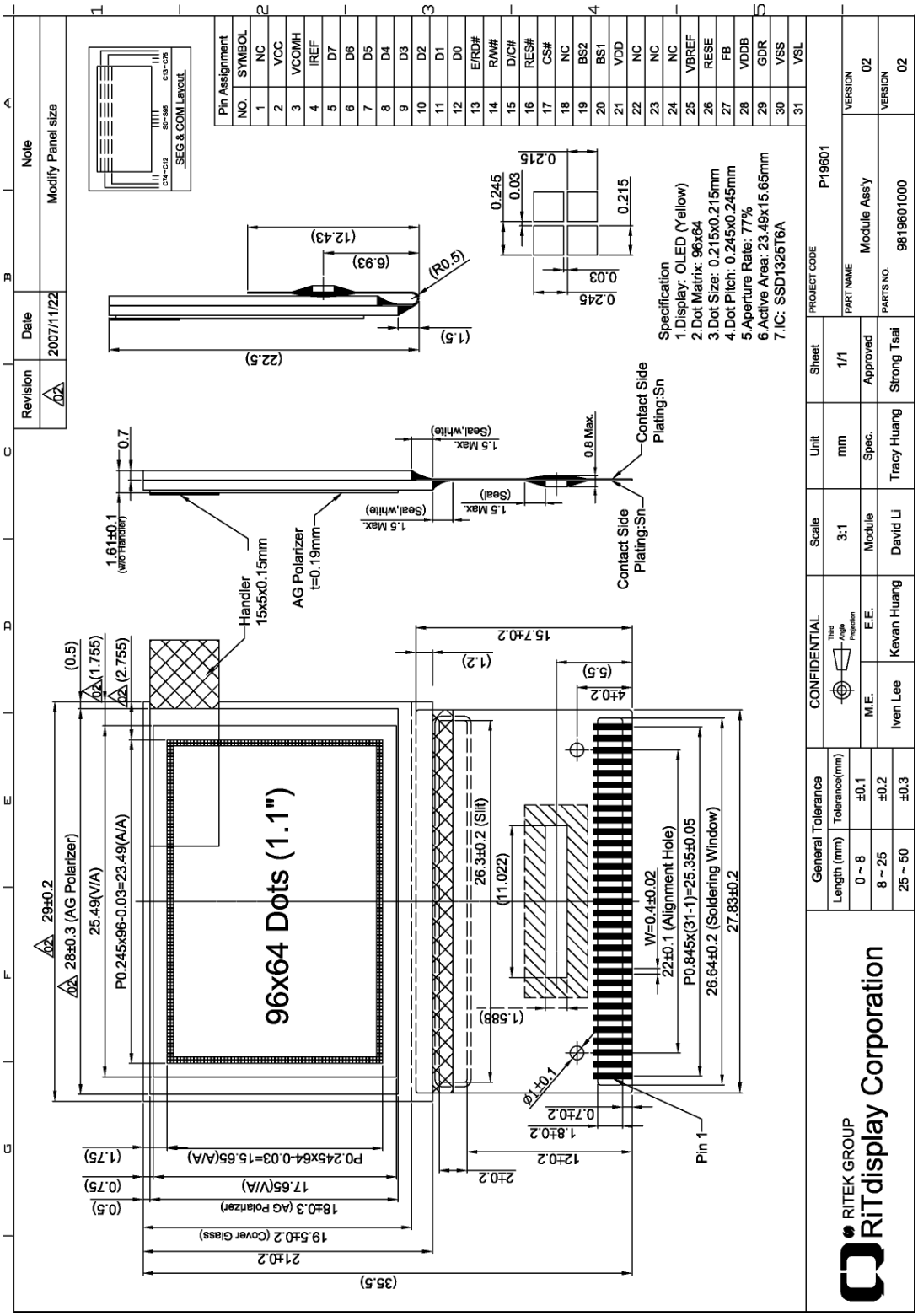
10. EXTERNAL DIMENSION



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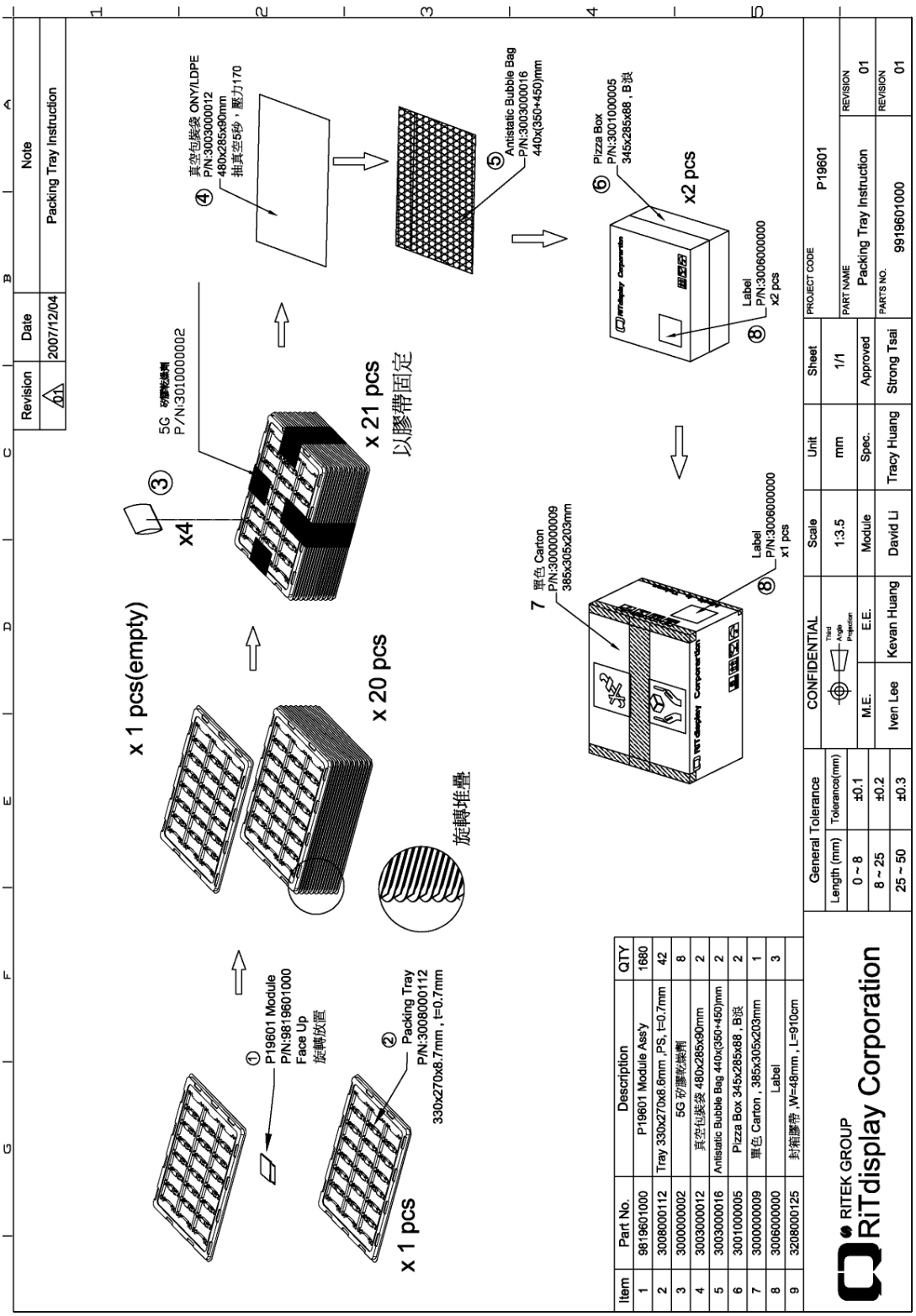
11. PACKING SPECIFICATION



12. APPENDIXES

APPENDIX 1: DEFINITIONS

A. DEFINITION OF CHROMATICITY COORDINATE

The chromaticity coordinate is defined as the coordinate value on the CIE 1931 color chart for R, G, B, W.

B. DEFINITION OF CONTRAST RATIO

The contrast ratio is defined as the following formula:

$$\text{Contrast Ratio} = \frac{\text{Luminance of all pixels on measurement}}{\text{Luminance of all pixels off measurement}}$$

C. DEFINITION OF RESPONSE TIME

The definition of turn-on response time Tr is the time interval between a pixel reaching 10% of steady state luminance and 90% of steady state luminance. The definition of turn-off response time Tf is the time interval between a pixel reaching 90% of steady state luminance and 10% of steady state luminance. It is shown in Figure 2.

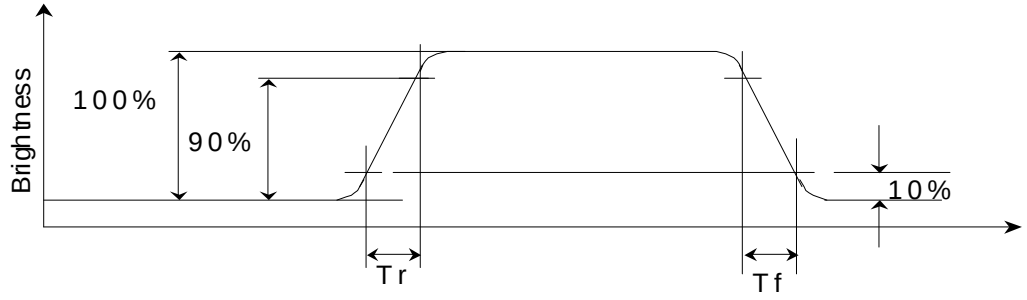


Figure 2: Response time

D. DEFINITION OF VIEWING ANGLE

The viewing angle is defined as Figure 3. Horizontal and vertical (H & V) angles are determined for viewing directions where luminance varies by 50% of the perpendicular value.

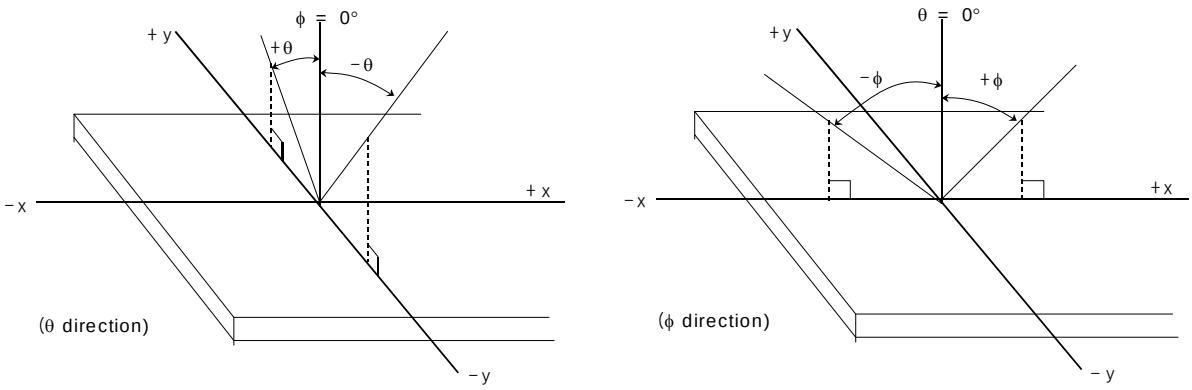
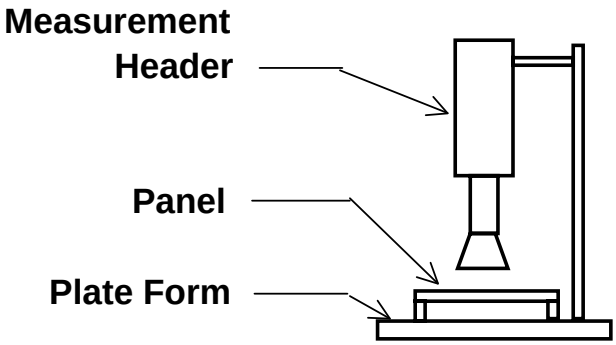


Figure 3: Viewing Angle

APPENDIX 2: MEASUREMENT APPARATUS

A. LUMINANCE/COLOR COORDINATE

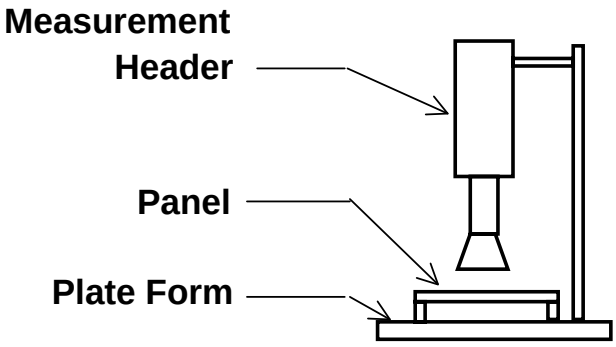
PHOTO RESEARCH PR-705, MINOLTA CS-100



**PR-705 /
MINOLTA CS-100
Color Analyzer**

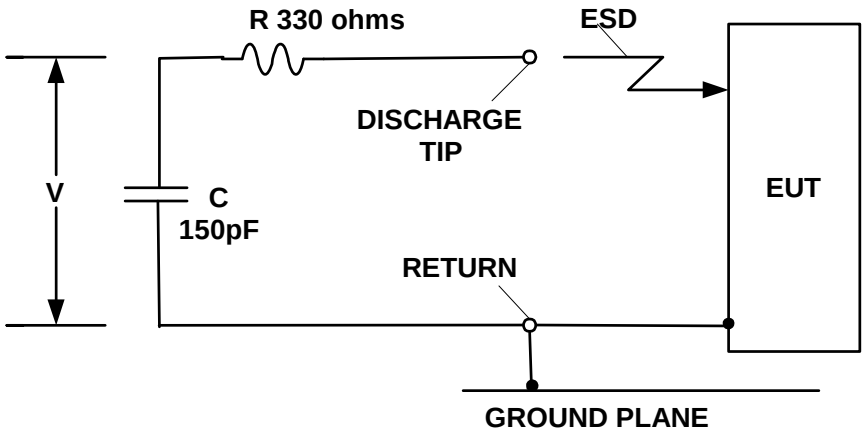
B. CONTRAST / RESPONSE TIME / VIEW ANGLE

WESTAR CORPORATION FPM-510



**Westar FPM-510
Display Contrast /
Response time /
View angle Analyzer**

C. ESD ON AIR DISCHARGE MODE



APPENDIX 3: PRECAUTIONS

A. RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

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